

**DECLARATION FOR PATENT APPLICATION AND APPOINTMENT OF ATTORNEY**

As a below named inventor, I hereby declare that my residence, post office address and citizenship are as stated below next to my name; I believe that I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention (Design, if applicable) entitled **METHOD FOR FABRICATING HIGH DENSITY OF MULTI-POLYIMIDE-LAYER**

**DPC LINES ON A CERAMIC BOARD**  
the specification of which (check one):

☒ is attached hereto.

☐ was filed on:

as Application Serial No.:

and (if applicable) was amended on:

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment(s) referred to above. I acknowledge the duty to disclose information which is material to patentability as defined in **Title 37, Code of Federal Regulations, § 1.56**. I hereby claim foreign priority benefits under **Title 35, United States Code § 119** of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed.

PRIOR FOREIGN APPLICATION(S)			PRIORITY CLAIMED	
Number	Country	Day/Month/Year Filed	Yes	No

I hereby claim the benefit under **Title 35, United States Code, § 120** of any United States application(s) or PCT international application(s) designating The United States of America listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in that/those prior application(s) in the manner provided by the first paragraph of **Title 35, United States Code, § 112**, I acknowledge the duty to disclose information which is material to patentability as defined in **Title 37, Code of Federal Regulations, § 1.56** which became available between the filing date of the prior application(s) and the national or PCT international filing date of this application:

Application Number	Filing Date	Status - Patented, Pending or Abandoned

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under **section 1001 of title 18 of the United States Code** and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

**POWER OF ATTORNEY:** I(We) hereby appoint as my(our) attorneys, with full powers of substitution and revocation, to prosecute this application and transact all business in the Patent and Trademark Office connected therewith:


James H. Walters 35731; Michael O. Scheinberg 36919

I(We) authorize my(our) attorneys to accept and follow instructions from **TAI E INTERNATIONAL PATENT & LAW OFFICE** regarding any matter related to the preparation, examination, grant and maintenance of this application, any continuation, continuation-in-part or divisional based thereon, and any patent resulting therefrom, until I(We) or my(our) assigns withdraw this authorization in writing.

Send correspondence to: Dellett and Walters

Telephone Calls to: 503 224 0115

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Full Name of First or Sole Inventor		Shao-Pin RU	
Post Office Address	<input checked="" type="checkbox"/> Same as Residence	Citizenship	Taiwan
Residence Address 4th Fl., No. 85, Yen Ping S. Rd., Taipei, Taiwan			
DATE	September 8, 2003	SIGNATURE	
Full Name of Joint Inventor			
Post Office Address	<input checked="" type="checkbox"/> Same as Residence	Citizenship	
Residence Address			
DATE		SIGNATURE	

☐ See following pages for additional joint inventors.

POWER OF ATTORNEY

Docket No. T-1256

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

Inventor(s): Shao-Pin RU

Title: METHOD FOR FABRICATING HIGH DENSITY OF MULTI-POLYIMIDE-LAYER DPC LINES  
ON A CERAMIC BOARD

POWER OF ATTORNEY

Hon. Commissioner of Patents and Trademarks

Washington, D.C. 20231

Sir:

TONG HSING ELECTRIC INDUSTRIES LTD.

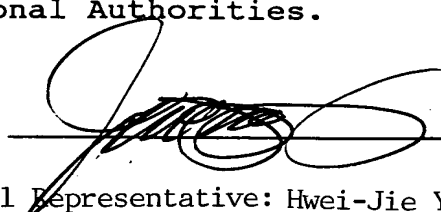
having become the owner of all rights in and to the above-identified application by virtue of an Assignment executed by the inventor(s) concurrently with the execution of the application, said Assignment being submitted herewith for recording, hereby appoints:

James H. Walters 35731; Michael O. Scheinberg 36919

Whose address is: Dellett and Walters  
Suite 1101  
310 S.W. Fourth Avenue  
Portland, OR 97204  
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their attorneys to prosecute said application and to transact in connection therewith all business in the Patent and Trademark office and before competent International Authorities.

Date: September 8, 2003

  
Legal Representative: Hwei-Jie YANG